

V <sub>DSS</sub>	400V
R <sub>DS(on)</sub> (Typ.)	120mΩ
I <sub>D</sub>	20A
P <sub>D</sub>	132W

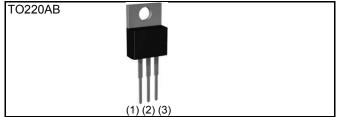
#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

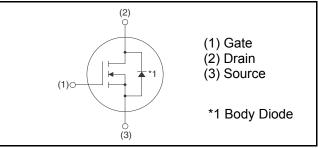
#### Application

Audio

#### Outline



#### Inner circuit



#### Packaging specifications

	Packing	Tube
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	50
	Packing code	С
	Marking	SCTMU001F

## ●Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	400	V
Continuous drain current $T_c = 25^{\circ}C$	ا <sub>D</sub> *1	20	А
Pulsed drain current	I <sub>D,pulse</sub> *2	60	А
Gate - Source voltage	V <sub>GSS</sub>	-6 to 22	V
Power dissipation ( $T_c = 25^{\circ}C$ )	P <sub>D</sub>	132	W
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## SCTMU001F

#### Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}$	-	0.72	0.95	°C/W
Soldering temperature, wavesoldering for 10s	$T_{sold}$	-	-	265	°C

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol Conditions -		Values			Unit
Faranielei			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA	400	-	-	V
		V <sub>DS</sub> = 400V, V <sub>GS</sub> = 0V				
Zero gate voltage drain current	I <sub>DSS</sub>	T <sub>j</sub> = 25°C	-	0.1	1	μA
		T <sub>j</sub> = 150°C	-	0.5	-	
Gate - Source leakage current	I <sub>GSS+</sub>	V <sub>GS</sub> = +22V, V <sub>DS</sub> = 0V	-	-	100	nA
Gate - Source leakage current	I <sub>GSS-</sub>	$V_{GS}$ = -6V, $V_{DS}$ = 0V	-	-	-100	nA
Gate threshold voltage	$V_{GS\ (th)}$	$V_{DS} = V_{GS}, I_{D} = 3.3 \text{mA}$	1.6	-	4.0	V
		V <sub>GS</sub> = 18V, I <sub>D</sub> = 10A				
Static drain - source on - state resistance	$R_{DS(on)}$ *3	T <sub>j</sub> = 25°C	-	120	156	mΩ
		T <sub>j</sub> = 100°C	-	137	-	
Gate input resistance	R <sub>G</sub>	f = 1MHz, open drain	-	14	-	Ω

\*1 Limited only by maximum temperature allowed.

\*2 PW  $\leq$  10  $\mu s,$  Duty cycle  $\leq$  1%

\*3 Pulsed

# •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Conditions		Unit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	${\sf g}_{\sf fs}$	V <sub>DS</sub> = 10V, I <sub>D</sub> = 10A	-	2.7	-	S
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	1218	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 200V	-	102	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	14	-	
Turn - on delay time	t <sub>d(on)</sub> *3	V <sub>DD</sub> = 300V, I <sub>D</sub> = 5A	-	22	-	
Rise time	t <sub>r</sub> *3	V <sub>GS</sub> = 18V/0V	-	23	-	20
Turn - off delay time	t <sub>d(off)</sub> *3	R <sub>L</sub> = 60Ω	-	67	-	ns
Fall time	t <sub>f</sub> *3	$R_G = 0\Omega$	-	30	-	

# •Gate Charge characteristics ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Symbol Conditions	Values			Unit
Faranieler	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	$Q_g^{*3}$	V <sub>DD</sub> = 200V	-	59	-	
Gate - Source charge	${\sf Q_{gs}}^{*3}$	I <sub>D</sub> = 5A	-	13	-	nC
Gate - Drain charge	${\sf Q}_{\sf gd}$ *3	V <sub>GS</sub> = 18V	-	18	-	

# •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Faranielei	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Inverse diode continuous, forward current	ا <sub>S</sub> *1	T <sub>c</sub> = 25°C	-	-	20	A	
Inverse diode direct current, pulsed	$I_{\rm SM}$ *2	, ,	-	-	60	А	
Forward voltage	$V_{SD}^{*3}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A	-	4.3	-	V	
Reverse recovery time	t <sub>rr</sub> *3	1 - 100 = 100	-	29	-	ns	
Reverse recovery charge	Q <sub>rr</sub> *3	I <sub>F</sub> = 10A, V <sub>R</sub> = 400V di/dt = 165A/μs	-	53	-	nC	
Peak reverse recovery current	<sup>*3</sup>	αναι – 105Αγμs	-	3.1	-	А	

## •Electrical characteristic curves

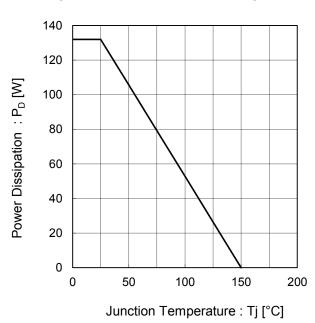
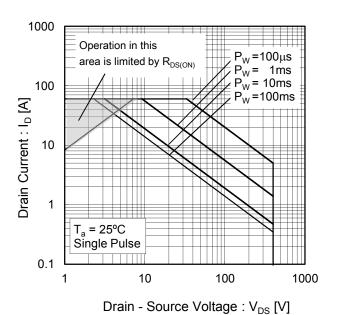
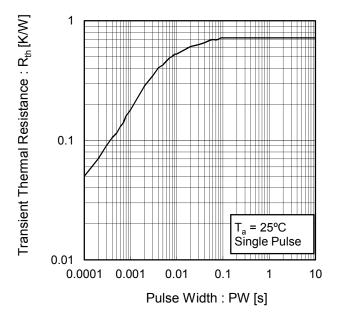


Fig.1 Power Dissipation Derating Curve

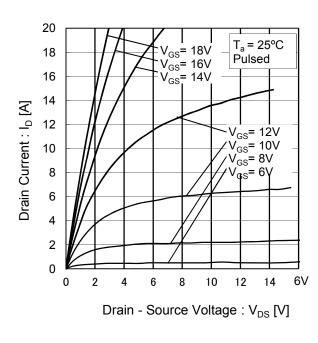


#### Fig.2 Maximum Safe Operating Area

Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



#### Electrical characteristic curves



#### Fig.4 Typical Output Characteristics

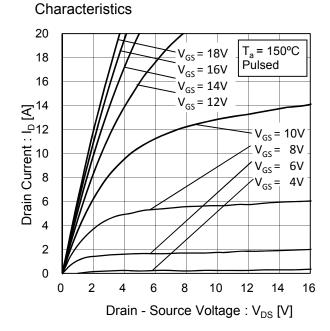


Fig.5 Tj = 150° C Typical Output

#### Fig.6 Typical Transfer Characteristics

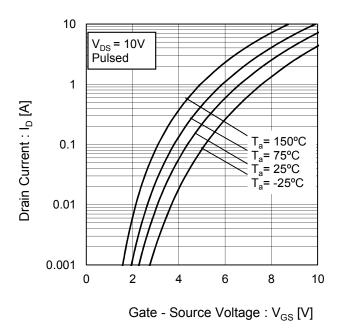
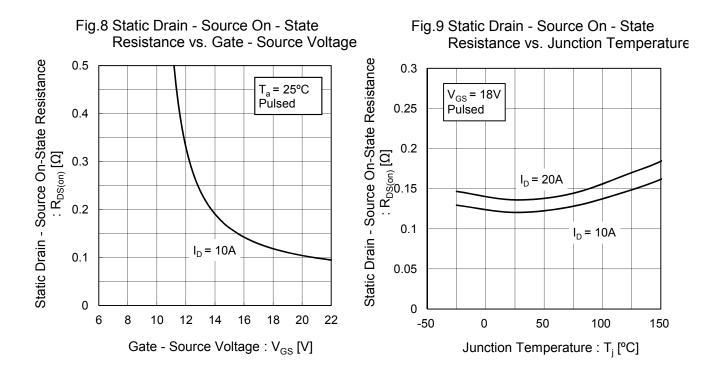


Fig.7 Gate Threshold Voltage vs. Junction Temperature 4  $V_{DS} = 10V$ 3.5 Gate Threshold Voltage : V  $_{GS(th)}$  [V]  $I_D = 3mA$ 3 2.5 2 1.5 1 0.5 0 -50 0 50 100 150

Junction Temperature : T<sub>i</sub> [°C]

#### Electrical characteristic curves



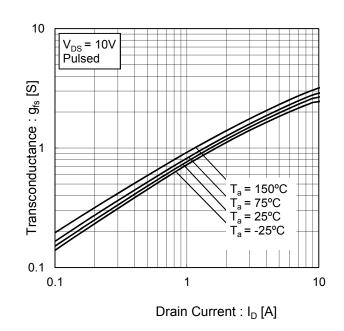
# Fig.10 Static Drain - Source On - State Resistance vs. Drain Current Static Drain - Source On-State Resistance 1 V<sub>GS</sub> = 18V Pulsed : $R_{DS(on)}$ [ $\Omega$ ] 150⁰C 125⁰C = 75°C = 25°C = -25°C 0.1 0.1 100

1

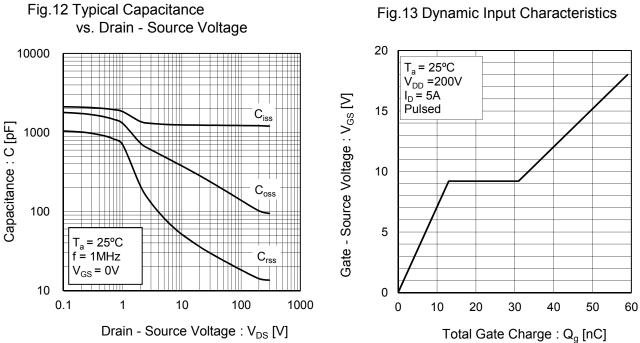
10

Drain Current : I<sub>D</sub> [A]

Fig.11 Transconductance vs. Drain Curren



#### Electrical characteristic curves



### Fig.14 Switching Characteristics

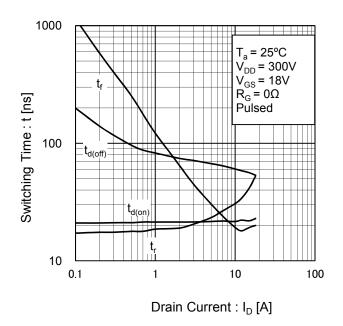


Fig.13 Dynamic Input Characteristics

#### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

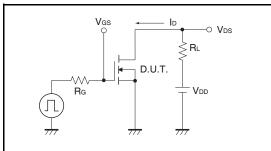
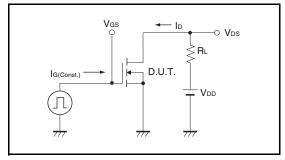
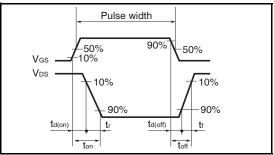
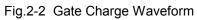


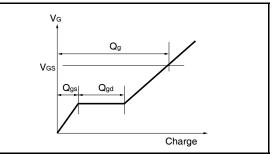
Fig.2-1 Gate Charge Measurement Circuit



#### Fig.1-2 Switching Waveforms

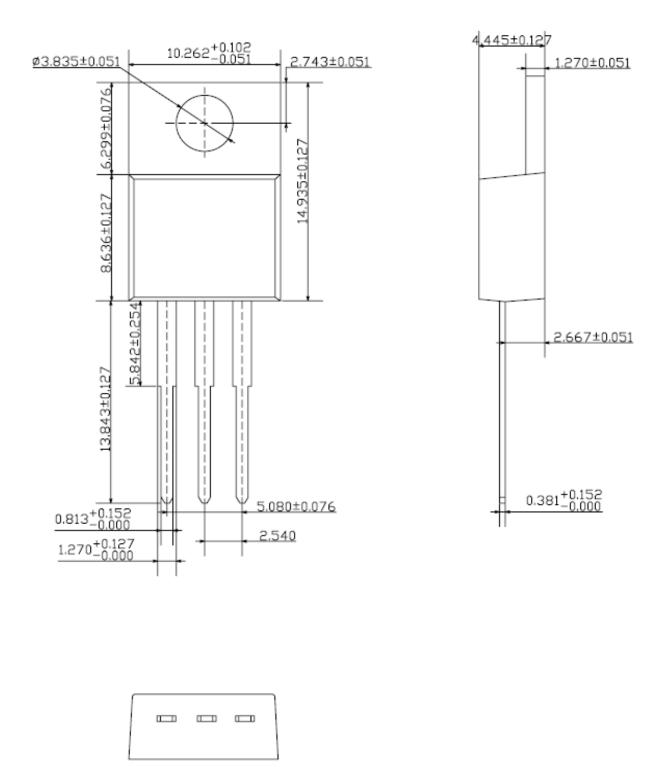






### •Dimensions (Unit : mm)

### **TO-220AB**



	Notes
1)	The information contained herein is subject to change without notice.
2)	Before you use our Products, please contact our sales representative and verify the latest specifications :
3)	Although ROHM is continuously working to improve product reliability and quality, semicon ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
4)	Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The periphera conditions must be taken into account when designing circuits for mass production.
5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly any license to use or exercise intellectual property or other rights held by ROHM or any othe parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
6)	The Products specified in this document are not designed to be radiation tolerant.
7)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
8)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
9)	ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
10)	ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
11)	Please use the Products in accordance with any applicable environmental laws and regulations such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
12)	When providing our Products and technologies contained in this document to other countries you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
4.0)	This document, in part or in whole, may not be reprinted or reproduced without prior consent of



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

# ROHM Customer Support System

http://www.rohm.com/contact/